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# Technical Data Sheet Dissipator<sup>®</sup> 745

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# **Product Description**

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**Hernon**<sup>®</sup> **Dissipator**<sup>®</sup> **745** is a thermally conductive room temperature cure adhesive that is designed for bonding electrical components to heat sink with a controlled gap.

**Dissipator**<sup>®</sup> **745**, through a special shimming property, insulates the component electrically while allowing thermal conductivity. This special shimming feature of produces a constant gap of 0.005 in. to 0.006 in. between components.

#### **Product Benefits**

- No mixing required (eliminates errors in mixing ratio)
- Room temperature cure. No heat required
- Eliminates screws and rivets for assembly
- Eliminates the air space between components
- High k factor for heat conductive application

# **Typical Properties (Uncured)**

Property	Value
Chemical type	Modified acrylic
Appearance	Light blue paste
Viscosity at 77ºF (25ºC), cP	300,000 to 800,000
Specific gravity	1.63
Flash point	See MSDS

# **Typical Properties (Cured)**

#### **Physical Properties**

Property	Value
Coefficient of thermal expansion, ASTM D696 (K <sup>-1</sup> )	69 x 10 <sup>-6</sup>
Coefficient of thermal conductivity, ASTM C 177, W/(m·K)	1.215
Tensile Strength at break, ISO 527, N/mm² (psi)	15.2 (2,200)
Elongation at break, ISO 527, %	1
Young's Modulus, N/mm² (psi)	2,690 (390,000)
Temperature Range, °C (°F)	-55 to 150 (-65 to 300)

#### **Electrical Properties**

Property	Value
Dielectric Strength, kV/mm IEC 60243-1, kV/mm	26.7
Dielectric Constant @ 100 Hz IEC 60250 1 kHz 1 MHz	6.17 5.62 4.99
Dissipation Factor @ 100 Hz IEC 60250 1 kHz 10 kHz	0.09 0.04 0.03
Volume Resistivity, Ω·cm, IEC 60093	1.3 × 10 <sup>12</sup>
Surface Resistivity, Ω, IEC 60093	1.2 × 10 <sup>13</sup>

# **Typical Curing Performance**

**Dissipator**<sup>®</sup> **745**, when used with **Hernon**<sup>®</sup> **EF**<sup>®</sup> **Activator 63**, fixtures at room temperature in less than five minutes.

### Typical Cured Performance

Shear Strength, ISO 4587

EF<sup>®</sup> Activator 63 applied to one surface

Cure @ 22ºC	Substrates	N/mm² (psi)
1 hour	Steel	≥ 3.4 (≥ 500)
24 hours	Steel	≥ 12.4 (≥ 1500)
24 hours	Aluminum	≥ 12.4 (≥ 1500)
72 hours	Steel	≥ 17.2 (≥2500)
72 hours	Aluminum	≥13.8 (≥2000)
72 hours	Aluminum to Epoxy glass	≥2.06 (≥300)

### **Typical Environmental Resistance**

Cured for 72 hours @ 22°C.

steel lap-shear specimens (**EF**<sup>®</sup> **Activator 63** applied to one surface), Shear Strength, ISO 4587

#### Chemical/Solvent Resistance

Aged under conditions indicated for 720 hours and tested at 22°C.

Chemical/Solvent	Temp (ºC)	% of Initial Strength
Air	87	140
Water	87	75

### **General Information**

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

#### **Directions for use**

- 1. For best performance bond surfaces should be clean and free from grease.
- 2. Use applicator to apply the activator to the surface to be bonded.
- 3. After the solvent evaporates, the active ingredients will appear wet, and will remain active for up to 2 hours after application. Contamination of the surface before bonding should be prevented.
- 4. Apply adhesive to the unactivated surface.
- 5. Secure the assembly, and wait for the adhesive to fixture (approximately 5 minutes) before any further handling. Full cure occurs in 4 to 24 hours.
- 6. The amount of adhesive applied to the part or heat sink should be limited to the amount necessary to fill the bond and just enough to give a small fillet.
- 7. The dispensing or application of the adhesive should be done as to minimize air entrapment within the bondline.
- The successful application of this product depends on accurate dispensing on the parts to be bonded.
  Hernon<sup>®</sup> Equipment Engineers are available to assist you in selecting and implementing the appropriate dispensing equipment for your application.

### Storage

**Dissipator**<sup>®</sup> **745** should be stored in a cool, dry location in unopened containers at a temperature between 46°F to 85°F (8°C to 29°C) unless otherwise labeled. Optimal storage is at the lower half of this temperature range. To prevent contamination of unused material, do not return any material to its original container.

### **Dispensing Equipment**

**Hernon**<sup>®</sup> offers a complete line of semi and fully automated dispensing equipment. Contact **Hernon**<sup>®</sup> **Sales** for additional information.

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